Octal Buffer/Line Driver with 3-State Outputs

The MC74AC540/74ACT540 and MC74AC541/74ACT541 are octal buffer/line drivers designed to be employed as memory and address drivers, clock drivers and bus oriented transmitter/receivers. The MC74AC541/74ACT541 is a noninverting option of the MC74AC540/74ACT540.

These devices are similar in function to the MC74AC240/74ACT240 and MC74AC244/74ACT244 while providing flow-through architecture (inputs on opposite side from outputs). This pinout arrangement makes these devices especially useful as output ports for microprocessors, allowing ease of layout and greater PC board density.

Features

- 3-State Outputs
- Inputs and Outputs Opposite Side of Package, Allowing Easier Interface to Microprocessors
- Outputs Source/Sink 24 mA
- MC74AC540/74ACT540 Provides Inverted Outputs
- MC74AC541/74ACT541 Provides Noninverted Outputs
- 'ACT540 and 'ACT541 Have TTL Compatible Inputs
- These are Pb–Free Devices

TRUTH TABLE

Inputs			Out	puts
\overline{OE}_1	\overline{OE}_2	D	<i>'</i> 540	<i>'</i> 541
L H X L	L X H L	H X X L	L Z Z H	H Z Z L

H = HIGH Voltage Level

L = LOW Voltage Level X = Immaterial

Z = High Impedance



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ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

DEVICE MARKING INFORMATION

See general marking information in the device marking section on page 8 of this data sheet.

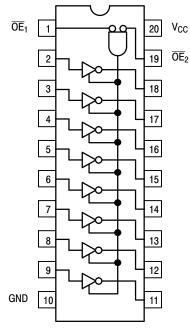


Figure 1. MC74AC540/74ACT540

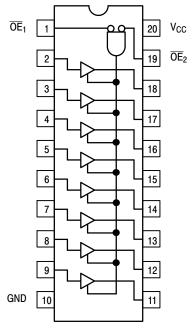


Figure 2. MC74AC541/74ACT541

MAXIMUM RATINGS

Symbol	Parameter		Value	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)		-0.5 to +7.0	V
V _{IN}	DC Input Voltage (Referenced to GND)		–0.5 to V _{CC} +0.5	V
V _{OUT}	DC Output Voltage (Referenced to GND) (Note 1)		–0.5 to V _{CC} +0.5	V
Ι _{ΙΚ}	DC Input Diode Current		±20	mA
I _{OK}	DC Output Diode Current		±50	mA
I _{OUT}	DC Output Sink/Source Current		±50	mA
I _{CC}	DC Supply Current, per Output Pin		±50	mA
I _{GND}	DC Ground Current, per Output Pin		±100	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
ΤL	Lead temperature, 1 mm from Case for 10 Seconds		260	°C
TJ	Junction Temperature Under Bias		140	°C
θ_{JA}	Thermal Resistance (Note 2)	SOIC TSSOP	65.8 110.7	°C/W
MSL	Moisture Sensitivity		Level 1	
F _R	Flammability Rating Oxygen	Index: 30% – 35%	UL 94 V–0 @ 0.125 in	
V _{ESD}	Machi	dy Model (Note 3) ne Model (Note 4) ce Model (Note 5)	> 2000 > 200 > 1000	V
I _{Latchup}	Latchup Performance Above V _{CC} and Below GNI	D at 85°C (Note 6)	±100	mA

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

I_{OUT} absolute maximum rating must be observed.
The package thermal impedance is calculated in accordance with JESD 51–7.

3. Tested to EIA/JESD22-A114-A.

4. Tested to EIA/JESD22-A115-A.

Tested to JESD22-C101-A. 5.

6. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Тур	Max	Unit		
N/	Quarky Valterra	'AC	2.0	5.0	6.0	v	
V _{CC}	Supply Voltage	'ACT	4.5	5.0	5.5	v	
V _{IN} , V _{OUT}	DC Input Voltage, Output Voltage (Ref. to GND)	0	-	V _{CC}	V		
t _r , t _f		V _{CC} @ 3.0 V	-	150	-		
	Input Rise and Fall Time (Note 1) 'AC Devices except Schmitt Inputs	V _{CC} @ 4.5 V	-	40	-	ns/V	
		V _{CC} @ 5.5 V	-	25	-		
	Input Rise and Fall Time (Note 2)	V _{CC} @ 4.5 V	-	10	-	201	
t _r , t _f	'ACT Devices except Schmitt Inputs V _{CC} @ 5.5 V		-	8.0	-	ns/V	
T _A	Operating Ambient Temperature Range			25	85	°C	
I _{OH}	Output Current – High			-	-24	mA	
I _{OL}	Output Current – Low			-	24	mA	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability. 1. V_{IN} from 30% to 70% V_{CC} ; see individual Data Sheets for devices that differ from the typical input rise and fall times. 2. V_{IN} from 0.8 V to 2.0 V; see individual Data Sheets for devices that differ from the typical input rise and fall times.

DC CHARACTERISTICS

			74AC		74AC		
		Vcc	T _A = -	⊦25°C	T _A = −40°C to +85°C		
Symbol	Parameter	(V)	Typ Guaranteed L		aranteed Limits	Unit	Conditions
V _{IH}	Minimum High Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	2.1 3.15 3.85	2.1 3.15 3.85	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V _{IL}	Maximum Low Level Input Voltage	3.0 4.5 5.5	1.5 2.25 2.75	0.9 1.35 1.65	0.9 1.35 1.65	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V _{OH}	Minimum High Level Output Voltage	3.0 4.5 5.5	2.99 4.49 5.49	2.9 4.4 5.4	2.9 4.4 5.4	V	l _{OUT} = -50 μA
		3.0 4.5 5.5	- -	2.56 3.86 4.86	2.46 3.76 4.76	V	$\label{eq:VIN} \begin{array}{c} {}^{*} V_{IN} = V_{IL} \text{ or } V_{IH} \\ -12 \text{ mA} \\ I_{OH} -24 \text{ mA} \\ -24 \text{ mA} \end{array}$
V _{OL}	Maximum Low Level Output Voltage	3.0 4.5 5.5	0.002 0.001 0.001	0.1 0.1 0.1	0.1 0.1 0.1	V	I _{OUT} = 50 μA
		3.0 4.5 5.5		0.36 0.36 0.36	0.44 0.44 0.44	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ 12 mA I_{OL} 24 mA 24 mA
I _{IN}	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μΑ	$V_{I} = V_{CC}, GND$
I _{OZ}	Maximum 3-State Current	5.5	-	±0.5	±5.0	μΑ	$V_{I} (OE) = V_{IL}, V_{IH}$ $V_{I} = V_{CC}, GND$ $V_{O} = V_{CC}, GND$
I _{OLD}	†Minimum Dynamic	5.5	-	-	75	mA	V _{OLD} = 1.65 V Max
I _{OHD}	Output Current	5.5	-	-	-75	mA	V _{OHD} = 3.85 V Min
I _{CC}	Maximum Quiescent Supply Current	5.5	-	8.0	80	μΑ	$V_{IN} = V_{CC}$ or GND

*All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

NOTE: I_{IN} and I_{CC} @ 3.0 V are guaranteed to be less than or equal to the respective limit @ 5.5 V V_{CC}.

			74AC T _A = +25°C C _L = 50 pF			74	AC		
		V _{cc} *				T _A = -40°C to +85°C C _L = 50 pF			Fig
Symbol	Parameter	(V)	Min	Тур	Max	Min	Max	Unit	No
t _{PLH}	Propagation Delay Data to Output ('AC540)	3.3 5.0	1.5 1.5	5.5 4.0	7.5 6.0	1.0 1.0	8.0 6.5	ns	3–:
t _{PHL}	Propagation Delay Data to Output ('AC540)	3.3 5.0	1.5 1.5	5.0 4.0	7.0 5.5	1.0 1.0	7.5 6.0	ns	3–
t _{PZH}	Output Enable Time ('AC540)	3.3 5.0	3.0 2.0	8.5 6.5	11 8.5	2.5 2.0	12 9.5	ns	3–
t _{PZL}	Output Enable Time ('AC540)	3.3 5.0	2.5 2.0	7.5 6.0	10 7.5	2.0 1.5	11 8.5	ns	3-
t _{PHZ}	Output Disable Time ('AC540)	3.3 5.0	2.5 1.5	8.5 7.5	13 10.5	1.5 1.0	14 11	ns	3–
t _{PLZ}	Output Disable Time ('AC540)	3.3 5.0	2.0 1.5	7.0 6.0	10 8.0	2.0 1.5	11 9.0	ns	3–
t _{PLH}	Propagation Delay Data to Output ('AC541)	3.3 5.0	2.0 1.5	5.5 4.0	8.0 6.0	1.5 1.0	9.0 6.5	ns	3–
t _{PHL}	Propagation Delay Data to Output ('AC541)	3.3 5.0	2.0 1.5	5.5 4.0	8.0 6.0	1.5 1.0	8.5 6.5	ns	3-
t _{PZH}	Output Enable Time ('AC541)	3.3 5.0	3.0 2.0	8.0 6.0	11.5 8.5	3.0 1.5	12.5 9.5	ns	3–
t _{PZL}	Output Enable Time ('AC541)	3.3 5.0	2.5 1.5	7.0 5.5	10 7.5	2.5 1.0	11.5 8.5	ns	3–
t _{PHZ}	Output Disable Time ('AC541)	3.3 5.0	3.5 2.0	9.0 7.0	12.5 9.5	2.5 1.0	14 10.5	ns	3–
t _{PLZ}	Output Disable Time ('AC541)	3.3 5.0	2.5 2.0	6.5 5.5	9.5 7.5	2.0 1.0	10.5 8.5	ns	3–

*Voltage Range 3.3 V is 3.3 V ±0.3 V. Voltage Range 5.0 V is 5.0 V ±0.5 V.

DC CHARACTERISTICS

			74A	СТ	74ACT		
		V _{cc}	T _A = +25°C		T _A = −40°C to +85°C		
Symbol	Parameter	(V)	Тур	Gu	aranteed Limits	Unit	Conditions
V _{IH}	Minimum High Level Input Voltage	4.5 5.5	1.5 1.5	2.0 2.0	2.0 2.0	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V _{IL}	Maximum Low Level Input Voltage	4.5 5.5	1.5 1.5	0.8 0.8	0.8 0.8	V	$V_{OUT} = 0.1 V$ or $V_{CC} - 0.1 V$
V _{OH}	Minimum High Level Output Voltage	4.5 5.5	4.49 5.49	4.4 5.4	4.4 5.4	V	I _{OUT} = -50 μA
		4.5 5.5		3.86 4.86	3.76 4.76	V	$V_{IN} = V_{IL} \text{ or } V_{IH}$ $I_{OH} -24 \text{ mA}$ -24 mA
V _{OL}	Maximum Low Level Output Voltage	4.5 5.5	0.001 0.001	0.1 0.1	0.1 0.1	V	I _{OUT} = 50 μA
		4.5 5.5	- -	0.36 0.36	0.44 0.44	V	$*V_{IN} = V_{IL} \text{ or } V_{IH}$ 24 mA I_{OL} 24 mA
I _{IN}	Maximum Input Leakage Current	5.5	-	±0.1	±1.0	μΑ	$V_{I} = V_{CC}, GND$
ΔI_{CCT}	Additional Max. I _{CC} /Input	5.5	0.6	-	1.5	mA	$V_{I} = V_{CC} - 2.1 V$
I _{OZ}	Maximum 3-State Current	5.5	-	±0.5	±5.0	μΑ	$V_{I} (OE) = V_{IL}, V_{IH}$ $V_{I} = V_{CC}, GND$ $V_{O} = V_{CC}, GND$
I _{OLD}	†Minimum Dynamic	5.5	-	-	75	mA	V _{OLD} = 1.65 V Max
I _{OHD}	Output Current	5.5	-	-	-75	mA	V _{OHD} = 3.85 V Min
I _{CC}	Maximum Quiescent Supply Current	5.5	_	8.0	80	μΑ	$V_{IN} = V_{CC}$ or GND

*All outputs loaded; thresholds on input associated with output under test. †Maximum test duration 2.0 ms, one output loaded at a time.

	Parameter		74ACT T _A = +25°C C _L = 50 pF			744	CT		
Symbol		V _{CC} * (V)				T _A = -40°C to +85°C C _L = 50 pF		Unit	Fig. No.
			Min	Тур	Max	Min	Max		
t _{PLH}	Propagation Delay Data to Output ('ACT540)	5.0	1.0	_	7.0	1.0	7.5	ns	3–5
t _{PHL}	Propagation Delay Data to Output ('ACT540)	5.0	1.0	-	8.0	1.0	8.5	ns	3–5
t _{PZH}	Output Enable Time ('ACT540)	5.0	1.0	-	10.5	1.0	11.5	ns	3–7
t _{PZL}	Output Enable Time ('ACT540)	5.0	1.0	_	9.5	1.0	10.5	ns	3–8
t _{PHZ}	Output Disable Time ('ACT540)	5.0	1.0	_	12.0	1.0	12.5	ns	3–7
t _{PLZ}	Output Disable Time ('ACT540)	5.0	1.5	-	9.0	1.0	10	ns	3–8
t _{PLH}	Propagation Delay Data to Output ('ACT541)	5.0	1.5	_	7.5	1.0	8.0	ns	3–5
t _{PHL}	Propagation Delay Data to Output ('ACT541)	5.0	1.5	_	7.5	1.0	8.0	ns	3–5
t _{PZH}	Output Enable Time ('ACT541)	5.0	2.0	_	10.0	1.0	11.0	ns	3–7
t _{PZL}	Output Enable Time ('ACT541)	5.0	1.5	-	9.5	1.0	10.5	ns	3–8
t _{PHZ}	Output Disable Time ('ACT541)	5.0	2.0	_	11.0	1.0	12.0	ns	3–7
t _{PLZ}	Output Disable Time ('ACT541)	5.0	2.0	-	9.0	1.0	10	ns	3–8

AC CHARACTERISTICS (For Figures and Waveforms – See AND8277/D at www.onsemi.com)

*Voltage Range 5.0 V is 5.0 V ± 0.5 V.

CAPACITANCE

Symbol	Parameter	Value Typ	Unit	Test Conditions
C _{IN}	Input Capacitance	4.5	pF	V _{CC} = 5.0 V
C _{PD}	Power Dissipation Capacitance	30	pF	V _{CC} = 5.0 V

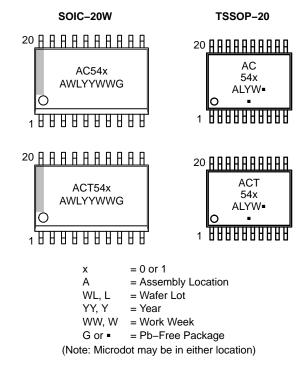
ORDERING INFORMATION

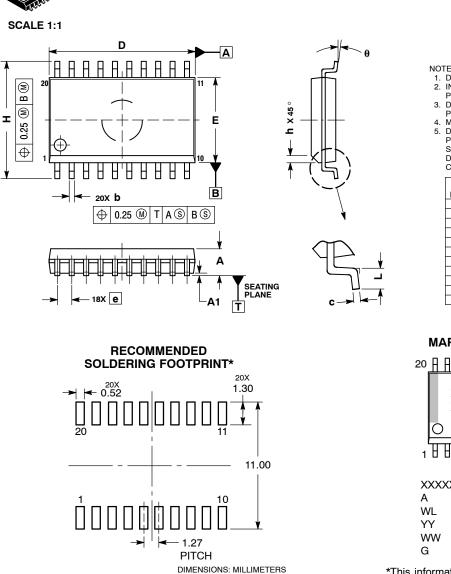
Device	Package	Shipping [†]
MC74AC540DWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74AC540DWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel
MC74ACT540DWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74ACT540DWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel
MC74ACT540DTR2G	TSSOP-20 (Pb-Free)	2500 / Tape & Reel
MC74AC541DWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74AC541DWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel
MC74ACT541DWG	SOIC-20 (Pb-Free)	38 Units / Rail
MC74ACT541DWR2G	SOIC-20 (Pb-Free)	1000 / Tape & Reel
MC74AC541DTR2G	TSSOP-20 (Pb-Free)	2500 / Tape & Reel
MC74ACT541DTG	TSSOP-20 (Pb-Free)	75 Units / Rail
MC74ACT541DTR2G	TSSOP-20 (Pb-Free)	2500 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

*These packages are inherently Pb-Free.

MARKING DIAGRAMS





*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DATE 22 APR 2015

DUSEM

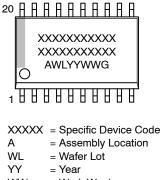
NOTES:

SOIC-20 WB CASE 751D-05 ISSUE H

- 1. DIMENSIONS ARE IN MILLIMETERS. 2. INTERPRET DIMENSIONS AND TOLERANCES
- PER ASME Y14.5M, 1994. 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
- DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS							
DIM	MIN	MAX						
Α	2.35	2.65						
A1	0.10	0.25						
b	0.35	0.49						
C	0.23	0.32						
D	12.65	12.95						
Е	7.40	7.60						
е	1.27	BSC						
Н	10.05	10.55						
h	0.25	0.75						
L	0.50	0.90						
θ	0 °	7 °						

GENERIC **MARKING DIAGRAM***



= Work Week = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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